International TOR Rectifier

PD - 91553F

IRFN9140

JANTX2N7236U JANTXV2N7236U JANS2N7236U REF:MIL-PRF-19500/595 100V, P-CHANNEL

HEXFET® MOSFETTECHNOLOGY

POWER MOSFET SURFACE MOUNT(SMD-1)

Product Summary

Part Number	RDS(on)	ΙD
IRFN9140	0.20Ω	-18A

HEXFET® MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.



Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Surface Mount
- Dynamic dv/dt Rating
- Light-weight

Absolute Maximum Ratings

The Part of the	Parameter		Units
ID @ VGS = -10V, TC = 25°C	Continuous Drain Current	-18	
ID @ VGS = -10V, TC = 100°C	Continuous Drain Current	-11	Α
IDM	Pulsed Drain Current ①	-72	-1.1
P _D @ T _C = 25°C	Max. Power Dissipation	125	W
	Linear Derating Factor	1.0	W/°C
VGS	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy ②	500	mJ
IAR	Avalanche Current ①	-18	Α
EAR	Repetitive Avalanche Energy ①	12.5	mJ
dv/dt	Peak Diode Recovery dv/dt 3	-5.0	V/ns
TJ	Operating Junction	-55 to 150	
TSTG	Storage Temperature Range		°C
1717 1-4	Package Mounting Surface Temperature	300 (for 5 S)	
	Weight	2.6(typical)	g

For footnotes refer to the last page



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Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	-100	_	_	V	VGS = 0V, ID = -1.0mA
ΔBV _{DSS} /ΔT _J	Temperature Coefficient of Breakdown Voltage	_	-0.087	_	V/°C	Reference to 25°C, I _D = -1.0mA
RDS(on)	Static Drain-to-Source On-State	_	_	0.20	0	VGS = -10V, ID = -11A@
, ,	Resistance	_	_	0.22	Ω	VGS = -10V, ID = -18A @
VGS(th)	Gate Threshold Voltage	-2.0	_	-4.0	V	V _{DS} = V _{GS} , I _D = -250μA
9fs	Forward Transconductance	6.2	_	_	S (5)	V _{DS} > -15V, I _{DS} = -11A@
IDSS	Zero Gate Voltage Drain Current	_	_	-25		V _{DS} = -80V, V _{GS} = 0V
		_	_	-250	μΑ	$V_{DS} = -80V$
						$V_{GS} = 0V, T_{J} = 125^{\circ}C$
IGSS	Gate-to-Source Leakage Forward	_	_	-100	nA	VGS = -20V
IGSS	Gate-to-Source Leakage Reverse	_	_	100	IIA	VGS = 20V
Qg	Total Gate Charge	_	_	60		$V_{GS} = -10V, ID_{=} -18A$
Qgs	Gate-to-Source Charge	_	_	13	nC	$V_{DS} = -50V$
Q _{gd}	Gate-to-Drain ('Miller') Charge	_	_	35.2		
^t d(on)	Turn-On Delay Time	_	_	35		$V_{DD} = -50V, I_{D} = -18A$
tr	Rise Time	_	_	85	ns	$RG = 9.1\Omega$, $VGS = -10V$
td(off)	Turn-Off Delay Time	_	_	85	115	
tf	Fall Time	_	_	65		
LS + LD	Total Inductance	_	4.0	_	nΗ	Measured from the center of drain pad to center of source pad
Ciss	Input Capacitance	_	1400			VGS = 0V, VDS = -25V
Coss	Output Capacitance	_	600	_	pF	f = 1.0MHz
C _{rss}	Reverse Transfer Capacitance	_	200	_		

Source-Drain Diode Ratings and Characteristics

	Parameter		Min	Тур	Max	Units	Test Conditions
Is	Continuous Source Current (I	Body Diode)	_	_	-18	Α	
ISM	Pulse Source Current (Body Diode) ①		_	_	-72	'`	
VSD	Diode Forward Voltage		_	_	-5.0	V	$T_j = 25$ °C, $I_S = -18A$, $V_{GS} = 0V$ ④
trr	Reverse Recovery Time		_	_	280	nS	$T_j = 25$ °C, $I_F = -18A$, $di/dt ≤ -100A/μs$
QRR	Reverse Recovery Charge		_	_	3.6	μc	V _{DD} ≤ -30V ④
ton Forward Turn-On Time Intrinsic turn-on time is negligible. Turn-on speed is substantial					eed is substantially controlled by L _S + L _D .		

Thermal Resistance

	Parameter	Min	Тур	Max	Units	Test Conditions
RthJC	Junction to Case	_	_	1.0	°C/W	
R _{th} J-PCB	Junction to PC Board	_	4.0	_	C/VV	Soldered to a copper-clad PC board

Note: Corresponding Spice and Saber models are available on International Rectifier Website. For footnotes refer to the last page

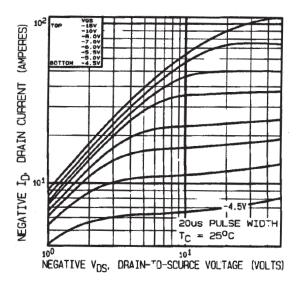


Fig 1. Typical Output Characteristics

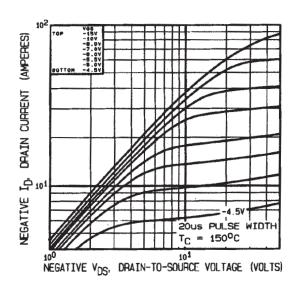


Fig 2. Typical Output Characteristics

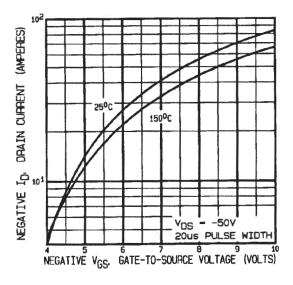


Fig 3. Typical Transfer Characteristics

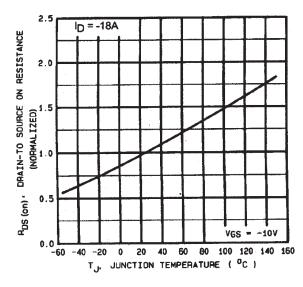


Fig 4. Normalized On-Resistance Vs. Temperature

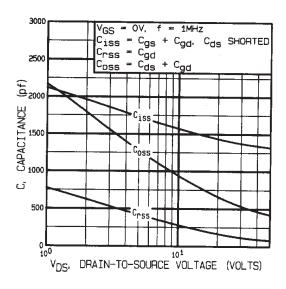
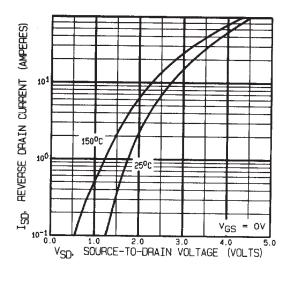


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage



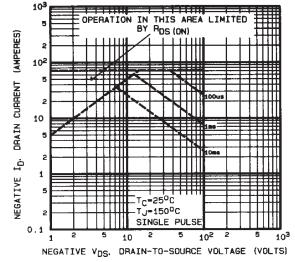


Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

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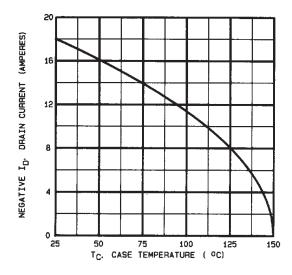


Fig 9. Maximum Drain Current Vs. Case Temperature

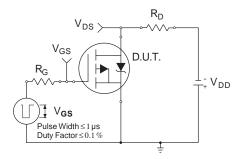


Fig 10a. Switching Time Test Circuit

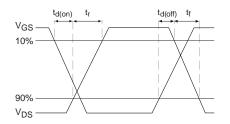


Fig 10b. Switching Time Waveforms

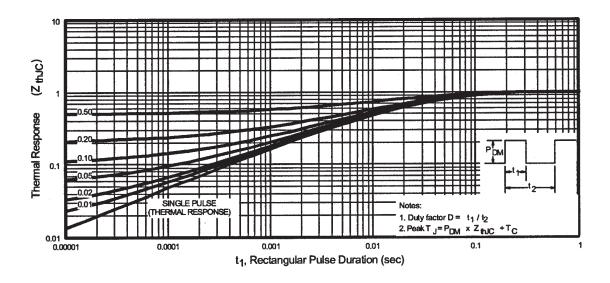


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

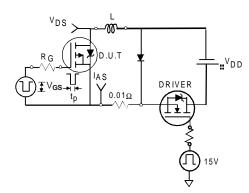
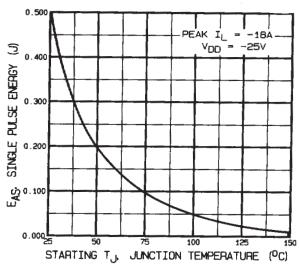


Fig 12a. Unclamped Inductive Test Circuit



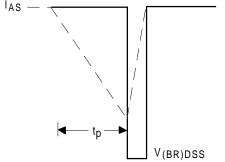
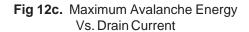


Fig 12b. Unclamped Inductive Waveforms



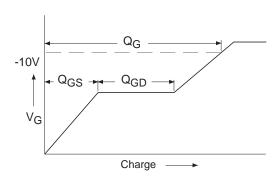


Fig 13a. Basic Gate Charge Waveform

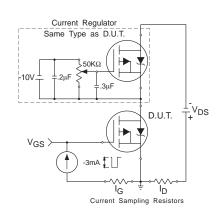


Fig 13b. Gate Charge Test Circuit

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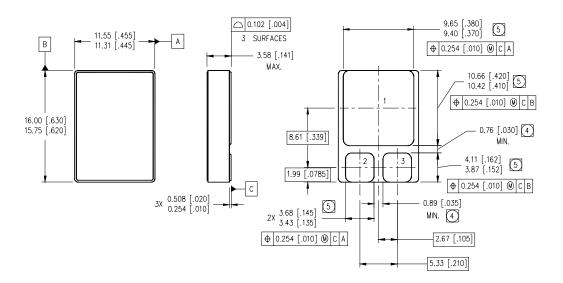
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Foot Notes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $^{\circ}$ V_{DD} =-25V, starting T_J = 25°C, L = 3.1mH Peak I_L = -18A, V_{GS} = -10V
- $\label{eq:local_state} \begin{tabular}{ll} \begin{tabular}{ll}$
- ④ Pulse width ≤ 300 μ s; Duty Cycle ≤ 2%

Case Outline and Dimensions — SMD-1



NOTES:

- 1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4 DIMENSION INCLUDES METALLIZATION FLASH.
- 5) DIMENSION DOES NOT INCLUDE METALLIZATION FLASH.

PAD ASSIGNMENTS

- 1- DRAIN
- 2- GATE
- 3-SOURCE



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